



Recommended P.C. Board Layout

- Material:
- \* Insulation: Glass filled Polyamide UL 94V-0 Color Black
  - \* Contact: Copper alloy, t=0.2mm
  - \* Fixed Tab: Brass, t=0.2mm
  - \* Plating code: Gold flash over Nickel
- DIM.A = 0.50 \* No. of Spaces  
 DIM.B = DIM.A + 3.0  
 DIM.C = DIM.A + 2.0  
 DIM.E = DIM.A + 2.0
- \* Available in 10 through 80 circuits

**X1017 W F-XX X-X**

- ① Series No.
  - ② Category: W-WAFER
  - ③ Wedging Board Angle: F-Female
  - ④ No. of Circuits
  - ⑤ Special No: S-With Positioning Column
  - ⑥ Height:
- A: Dim.D = 2.0mm (Circuits: 10~80pin)  
 C: DIM.D = 3.0mm (Circuits: 10~60pin)  
 D: DIM.D = 3.5mm (Circuits: 10~60pin)

ΔX					ANGULAR	±5°	DSND		DATE	SCALE: N/A	MODEL TYPE:	BTB CONNECTOR
ΔX					L ≤ 4	±0.2	DWN		DATE	VIEW:	PART NO.:	
ΔX					4 < L ≤ 16	±0.3	CHKD		DATE	UNIT: mm	DWG NO.:	X1017WF-XXX-X
MARK					16 < L ≤ 63	±0.4	APPD		DATE	SIZE: A4	WEIGHT	1.0g
REVISIONS				DATE	REVISED	APPROVED	UNSPECIFIED TOLERANCES					
DESCRIPTION				XKB INDUSTRIAL PRECISION CO., LIMITED								
www.xk-dg.com				www.hellokx.com				www.hellokx.cn				